

eMBB, URLLC, and mMTC with Cloud Agility, Elasticity, and Resiliency

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Where we are



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We've already got really great radio access systems.







But 5G & MEC alone would not be able to sustainably support cyber-physical applications



Where we should go : B5G Vision (Proposal)



eMBB, URLLC, and mMTC with Cloud Agility, Elasticity, and Resiliency



How could we achieve this vision?



Marriage between radio and optical networks

with IOWN All Photonics Network (APN)

IOWN : Innovative Optical and Wireless Networks

IOWN All Photonics Networks (APN)

Direct optical connections achieving guaranteed bandwidth and bounded latency



RAN Infrastructure with Cloud Agility, Elasticity, and Resiliency NTT CRANs cannot be sufficiently centralized with dark fibers.

CRAN with Dark Fibers (TODAY)





Cloud-and-Edge Computing





Dependable Radio under Pre-defined Mobility



Network operations like airplane flight operations

Airplanes can fly safely because

- They fly along pre-selected routes
- The weather condition of the routes is forecasted.
- The routes and schedules are updated based on the forecast



IOWN Global Forum

No one cannot achieve this vision alone.





- In January 2020, NTT, Intel and Sony established Innovative Optical and Wireless Network (IOWN) Global Forum for the future communication
- Global non-profit organization for developing the next generation communication and computing infrastructure with new technologies, frameworks, specifications and reference architectures



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IOWN Evolution Journey

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2022 and beyond

Technology Documents



PoC Reference

- Data-Centric-infrastructure-as-a-service PoC Reference
- RDMA over Open APN PoC Reference
- Mobile Fronthaul over APN PoC Reference
- Open APN Fiber Sensing PoC Reference
- IOWN Data Hub PoC Reference
- Open APN PoC Reference
- PoC Reference : Reference Implementation Model for the Area Management Security Use Case

Continuous technology updates through PoC activities



IOWN APN for EXPO 2025, Osaka, Kansai (Under Study)



Cloud-and-Edge Computing for EXPO 2025



Disclaimer: Still Under Internal Study

Conclusion



- eMBB, URLLC, mMTC with Cloud Agility, Elasticity, and Resiliency
- Marriage between Radio and Optical with IOWN APN
 - Cloudified RAN with IOWN APN
 - Cloud-and-Edge Computing with IOWN APN
- Dependable Radio
 - Network operations like airplane flight operations
 - under pre-defined mobility
- IOWN APN for EXPO 2025, Osaka, Kansai (under study)
 - Cloud-and-Edge Infrastructure for EXPO 2025

Beyond 5G推進コンソーシアム 国際委員会へのご登壇の件 (12/19(月) 13:00-15:00)



川島室長には 「IOWNのユースケース(遠隔合奏の実証実験等)と現状, 万博へのご展望などの内容」

を期待

【背景等】

・東大中尾教授が委員長の国際委員会の会合でのご登壇

・川島室長と尾上さんをピンポイントでご指名

・形式はオンライン

・発表は日本語でOK, 資料は英語が望ましいが日本語でもOK

・講演は通訳システムの関係上, Zoomとなる.

・登壇者は尾上さんと川島さんのみを想定している. それ以外は技術分科会の進捗共有等がある.

・尾上さんは会の冒頭, 川島さんはそのあとのご講演を想定している.

・お二方のご講演時間(長さ)は制限ないが,長くてもそれぞれ20分程度を想定している.

・ご講演後(質疑応答含む),退席してもしなくても構わない.